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APPLICATION N	Ο.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/512,223		02/24/2000	Martin Miehling	104142 5686	
25944	7590	04/18/2002			
OLIFF &	BERRII	DGE, PLC	EXAMINER		
P.O. BOX 19928 ALEXANDRIA, VA 22320			DINH, TUAN T		
				ART UNIT	PAPER NUMBER
				2827	
			DATE MAILED: 04/18/2002		

Please find below and/or attached an Office communication concerning this application or proceeding.

ريا ميان	Application No.	plicant(s)				
Advisory Action	09/512,223	MIEHLING, MARTIN				
Advicery Adden	Examiner	Art Unit				
	Tuan T Dinh	2827				
The MAILING DATE of this communication appe	ars on the cover sheet with the c	orrespondence address				
THE REPLY FILED 05 April 2002 FAILS TO PLACE THI Therefore, further action by the applicant is required to average final rejection under 37 CFR 1.113 may only be either: (1) condition for allowance; (2) a timely filed Notice of Appeal Examination (RCE) in compliance with 37 CFR 1.114.	oid abandonment of this applica a timely filed amendment which	ition. A proper reply to a				
PERIOD FOR RE	EPLY [check either a) or b)]					
 a) The period for reply expires 3 months from the mailing date b) The period for reply expires on: (1) the mailing date of this A no event, however, will the statutory period for reply expire is ONLY CHECK THIS BOX WHEN THE FIRST REPLY WAS 706.07(f). 	Advisory Action, or (2) the date set forth ater than SIX MONTHS from the mailing	date of the final rejection.				
Extensions of time may be obtained under 37 CFR 1.136(a). The fee have been filed is the date for purposes of determining the period of fee under 37 CFR 1.17(a) is calculated from: (1) the expiration date of (2) as set forth in (b) above, if checked. Any reply received by the Offic timely filed, may reduce any earned patent term adjustment. See 37 C	If extension and the corresponding amount the shortened statutory period for reply one to later than three months after the mail	unt of the fee. The appropriate extension originally set in the final Office action; or				
1. A Notice of Appeal was filed on Appellant's 37 CFR 1.192(a), or any extension thereof (37 CFF	•					
2. The proposed amendment(s) will not be entered because:						
(a) ☐ they raise new issues that would require further consideration and/or search (see NOTE below);						
(b) ☐ they raise the issue of new matter (see Note below);						
(c) they are not deemed to place the application ir issues for appeal; and/or	n better form for appeal by mater	rially reducing or simplifying the				
(d) they present additional claims without canceling NOTE:	ng a corresponding number of fi	nally rejected claims.				
3. \square Applicant's reply has overcome the following rejection	on(s):					
4. Newly proposed or amended claim(s) would canceling the non-allowable claim(s).	be allowable if submitted in a se	parate, timely filed amendment				
5.⊠ The a)☐ affidavit, b)☐ exhibit, or c)⊠ request for application in condition for allowance because: See		dered but does NOT place the				
6. The affidavit or exhibit will NOT be considered becaraised by the Examiner in the final rejection.	ause it is not directed SOLELY to	o issues which were newly				
7. For purposes of Appeal, the proposed amendments explanation of how the new or amended claims we						
The status of the claim(s) is (or will be) as follows:						
Claim(s) allowed:						
Claim(s) objected to:						
Claim(s) rejected: <u>1-15</u> .						
Claim(s) withdrawn from consideration:						
8. The proposed drawing correction filed on is	a)∏ approved or b)∏ disappr	oved by the Examiner.				
9. Note the attached Information Disclosure Statemen	nt(s)(PTO-1449) Paper No(s)	· .				
10. Other:						

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Continuation of 5. does NOT place the application in condition for allowance because: Examiner is still maintained a final rejection on 01/31/02, Hoppe ('763) discloses a molding compound (15), which is a thermal plastic powder, having a melting ponit to capsule a integrated circuit and an antenna into an electrical circuit.

DAVID L. TALBOTT SUPERVISORY PATENT EXAMINER

TECHNOLOGY CENTER 2800